



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No. : 10/512,135 Confirmation No. 2391
Applicant(s) : TSUMURA, *et al.* Customer No. 23838
Filed: : May 3, 2005
Art Unit : 1712
Title: : HARDENABLE COMPOSITION, HARDENING PRODUCT, PROCESS
FOR PRODUCING THE SAME AND LIGHT EMITTING DIODE
SEALED WITH THE HARDENING PRODUCT
Examiner : M. Zimmer

Mail Stop Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

APPLICANTS' COMMENTS TO EXAMINER'S
STATEMENT OF REASONS FOR ALLOWANCE

S I R:

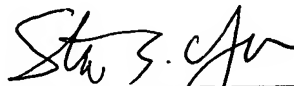
Applicants acknowledge with appreciation, Examiner's allowance of the claims. Applicants note for the record that claim 25 does not require that a borate ester condensation catalyst be present. Applicants also disagree with the Examiner's statements regarding Ouchi and maintain that claims 33 and 36-40 are novel and non-obvious over Ouchi.

The Examiner mentions that independent claim 33 does not contemplate the insertion of a borate ester compound. However, the present specification (on pg. 94, lns. 5-8) describe that the curable composition of the third aspect of the invention may contain the component (E). Moreover, claim 33 uses the term "contains" to show components in the composition. Therefore, claim 33 does not exclude the addition of the component (E).

The component (B) of claim 33 is clearly described in paragraph [0107] in the priority document (JP Application No. 2002-125947). On the other hand, Ouchi does not disclose the

component (B) of the present invention, which contains the reaction product(s) from the specific combination of compounds. Furthermore, Ouchi neither discloses nor suggests the excellent effects obtained by using the specific component (B) of the present invention.

Respectfully submitted,



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Date: 9 January 2008

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